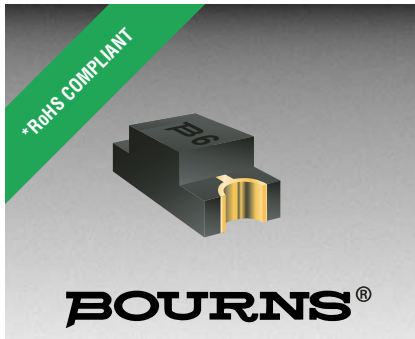




Features

- Lead free as standard
- RoHS compliant*
- Leadless
- Low stored charge

Applications

- Cellular phones
- PDAs
- Desktop PCs and notebooks
- Digital cameras
- MP3 players



CD0805-xxxx products are currently available, although not recommended for new designs. Use CD1005-xxxx products as an alternative.

Schottky Barrier Chip Diode Series - 0805

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers small-signal high-speed Schottky Barrier Diodes for switching and rectification applications, in compact chip package 0805 size format, which offer PCB real estate savings and are considerably smaller than competitive parts. The Schottky Barrier Diodes offer a forward current of 30 mA, 100 mA or 200 mA, a reverse voltage of 30 V, 40 V or 45V and also have a low forward voltage option. The diodes are lead-free with Cu/Ni/Au plated terminations and are compatible with lead-free manufacturing processes, conforming to many industry and government regulations on lead-free components.

Bourns® Chip Diodes conform to JEDEC standards, easy to handle on standard pick and place equipment and their flat configuration makes roll away much more difficult.

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD0805-B00340	CD0805-B0130	CD0805-B0130L	CD0805-B0145	CD0805-B0230	CD0805-B0245	Unit
Forward Voltage (Max.)	V _F	0.37 (I _f = 1 mA)	1.00 (I _f = 0.1 A)	0.44 (I _f = 0.1 A)	0.55 (I _f = 0.1 A)	0.50 (I _f = 0.2 A)	0.55 (I _f = 0.2 A)	V
Capacitance Between Terminals (Max.) (f = 1 MHz)	C _T	2 (V _r = 1 V)	6 (V _r = 10 V)	12 (V _r = 10 V)	6 (V _r = 10 V)	12 (V _r = 10 V)	12 (V _r = 10 V)	pF
Reverse Current (Max.)	I _R	1 (V _r = 40 V)	2 (V _r = 25 V)	30 (V _r = 30 V)	30 (V _r = 45 V)	30 (V _r = 30 V)	30 (V _r = 45 V)	μA

Absolute Ratings (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD0805-B00340	CD0805-B0130	CD0805-B0130L	CD0805-B0145	CD0805-B0230	CD0805-B0245	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	45	30	35	50	35	50	V
Reverse Voltage	V _R	40	30	30	45	30	45	V
Average Forward Current	I _O	30	100	100	100	200	200	mA
Forward Current, Surge Peak	I _{surge}	500*	1000*	1000*	1000*	3000*	3000*	mA
Power Dissipation	PD	200	300	300	300	300	250	mW
Storage Temperature	T _{STG}	-40 to +125						°C
Junction Temperature	T _J	-40 to +125						°C

* Condition: 8.3 ms single half sine-wave superimposed on rate load (JEDEC method).

How To Order

CD 0805 - B 01 30 L

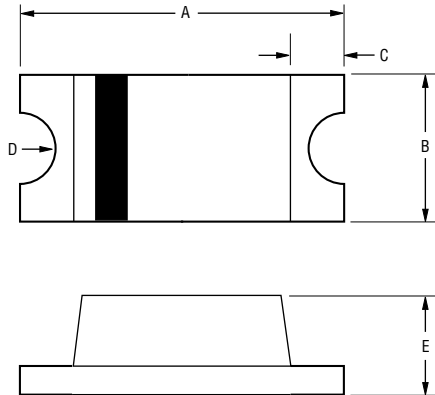
Common Code	_____	_____	_____	_____
Chip Diode	_____	_____	_____	_____
Package	_____	_____	_____	_____
• 0805	_____	_____	_____	_____
Model	_____	_____	_____	_____
B = Schottky Barrier Series	_____	_____	_____	_____
Average Forward Current (I _O) Code	_____	_____	_____	_____
003 = 30 mA	_____	_____	_____	_____
01 = 100 mA	_____	_____	_____	_____
02 = 200 mA	_____	_____	_____	_____
(Code x 1000 mA = Average Forward Current)	_____	_____	_____	_____
Reverse Voltage (V _R) Code	_____	_____	_____	_____
30 = 30 V	_____	_____	_____	_____
40 = 40 V	_____	_____	_____	_____
45 = 45 V	_____	_____	_____	_____
Forward Voltage Suffix	_____	_____	_____	_____
L = Low Forward Voltage V _f (CD0805-B0130L)	_____	_____	_____	_____

*RoHS Directive 2002/95/EC Jan 27 2003 including Annex
Specifications are subject to change without notice.
Customers should verify actual device performance in their specific applications.

Schottky Barrier Chip Diode Series - 0805

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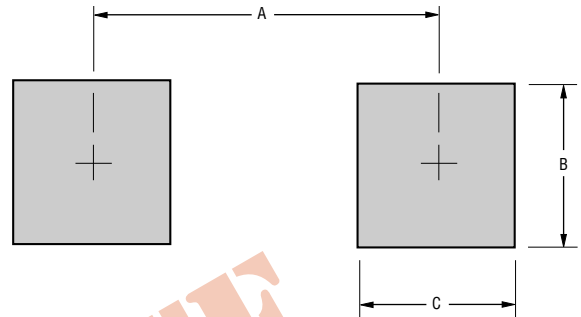
Product Dimensions



Dimension	0805
A	$\frac{2.00 - 2.20}{(0.079 - 0.087)}$
B	$\frac{1.20 - 1.40}{(0.047 - 0.055)}$
C	$\frac{0.40}{(0.016)}$ Typ.
D	$\frac{0.20}{(0.008)}$ R Typ.
E	$\frac{0.90 - 1.10}{(0.035 - 0.043)}$

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Recommended Pad Layout



Dimension	0805
A (Max.)	$\frac{2.10}{(0.082)}$
B (Min.)	$\frac{1.20}{(0.047)}$
C (Min.)	$\frac{1.20}{(0.047)}$

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Physical Specifications

Case.....0805(2012) Molded plastic
 TerminalsSolder plated, solderable per MIL-STD-750,
 Method 2026
 PolarityIndicated by cathode band
 Mounting PositionAny
 Weight0.000159 ounces / 0.0045 grams

Typical Part Marking

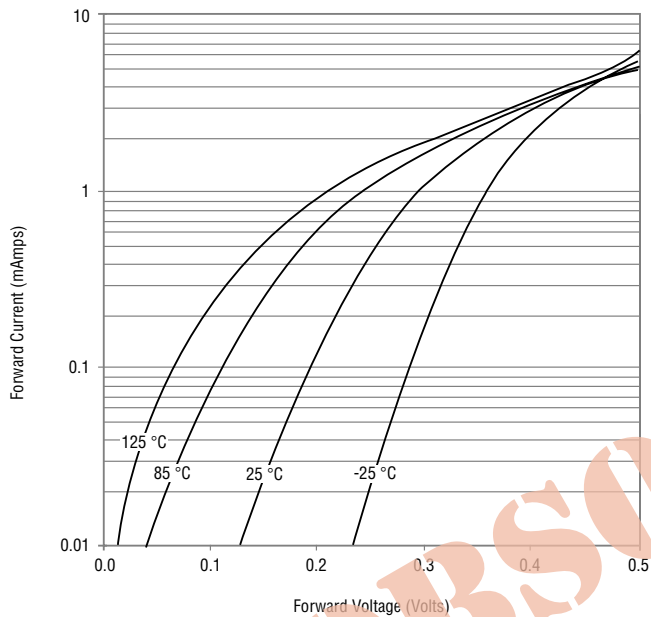
CD0805-B00340.....B2
 CD0805-B0130.....B1
 CD0805-B0130L.....B3
 CD0805-B0145.....B4
 CD0805-B0230.....B5
 CD0805-B0245.....B6

Schottky Barrier Chip Diode Series - 0805

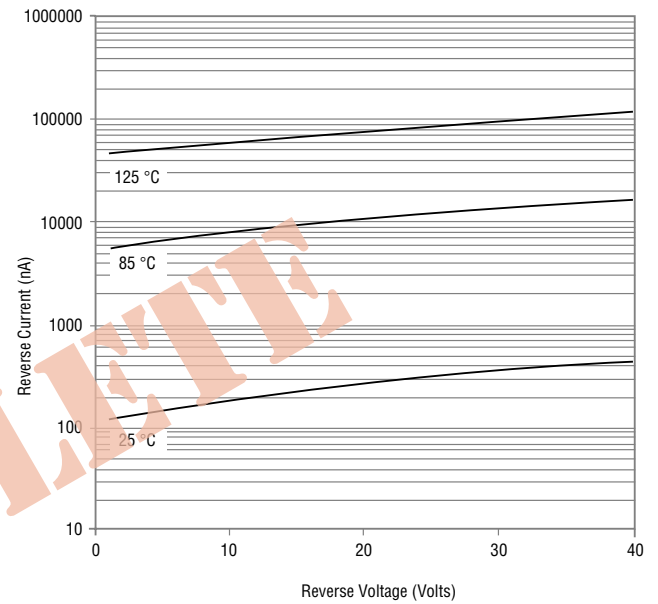
BOURNS®

Rating and Characteristic Curves: CD0805-B00340

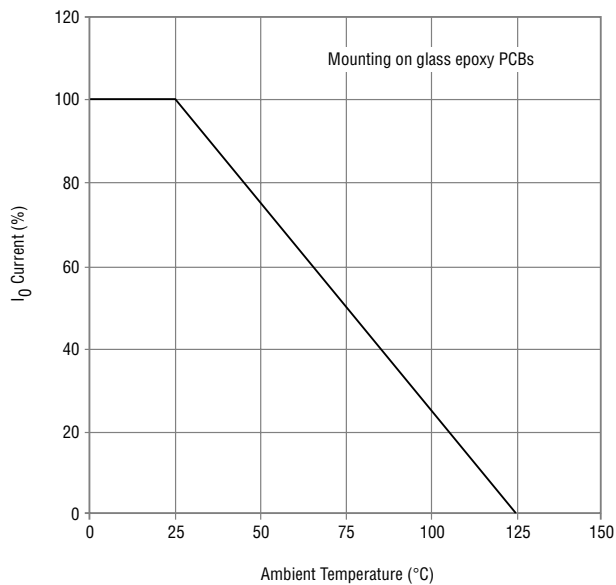
Forward Characteristics



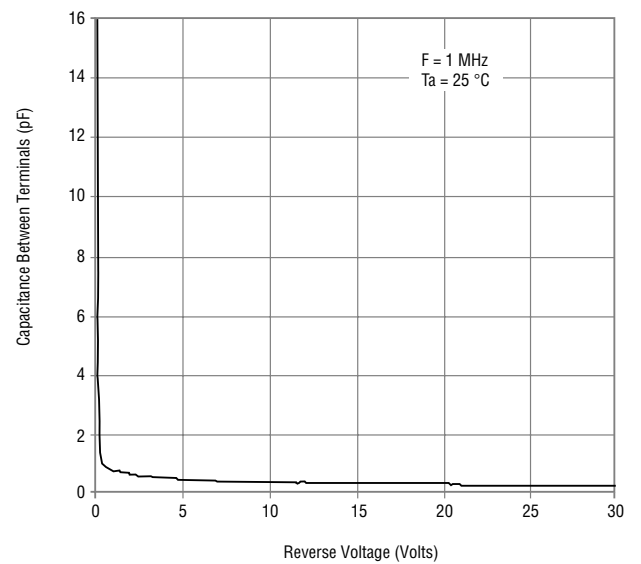
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

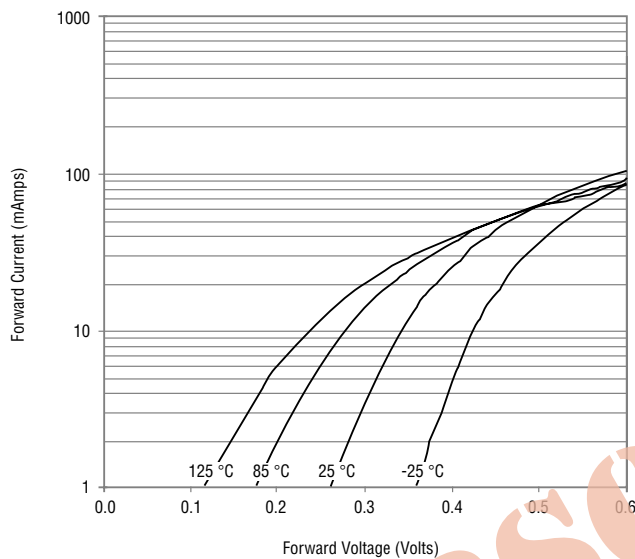


Schottky Barrier Chip Diode Series - 0805

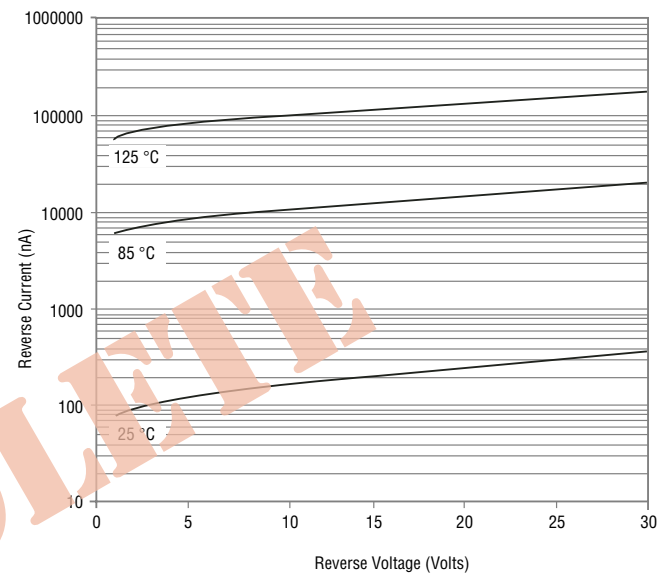
BOURNS®

Rating and Characteristic Curves: CD0805-B0130

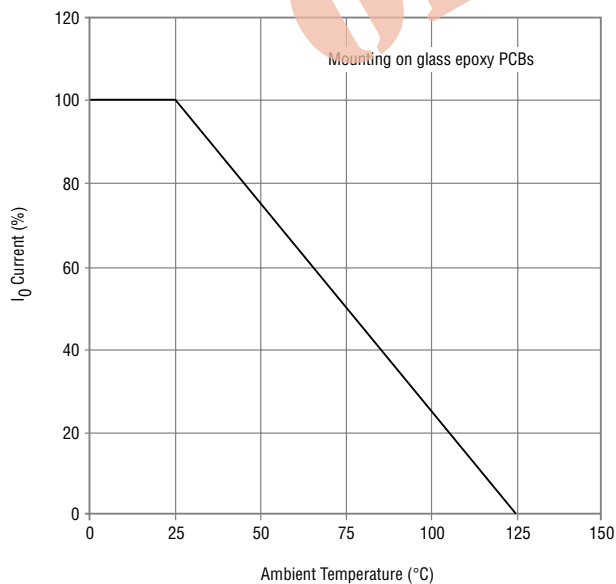
Forward Characteristics



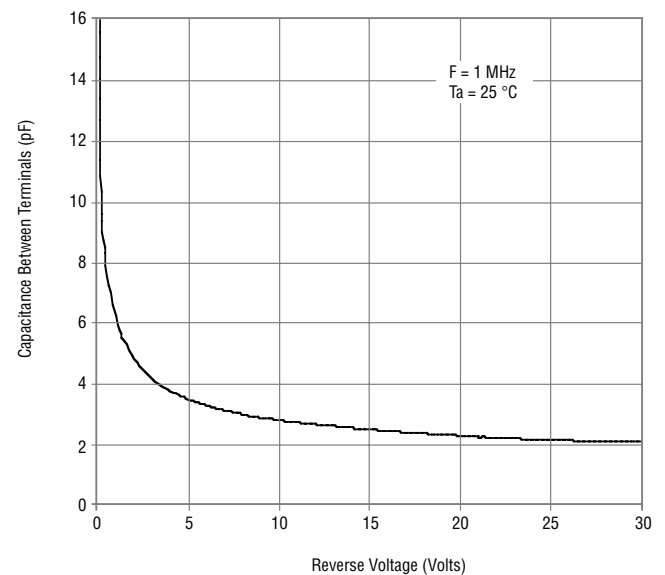
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

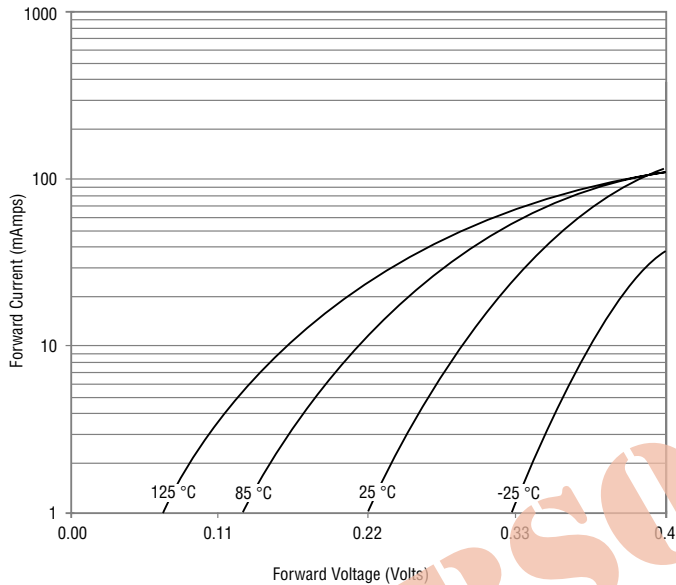


Schottky Barrier Chip Diode Series - 0805

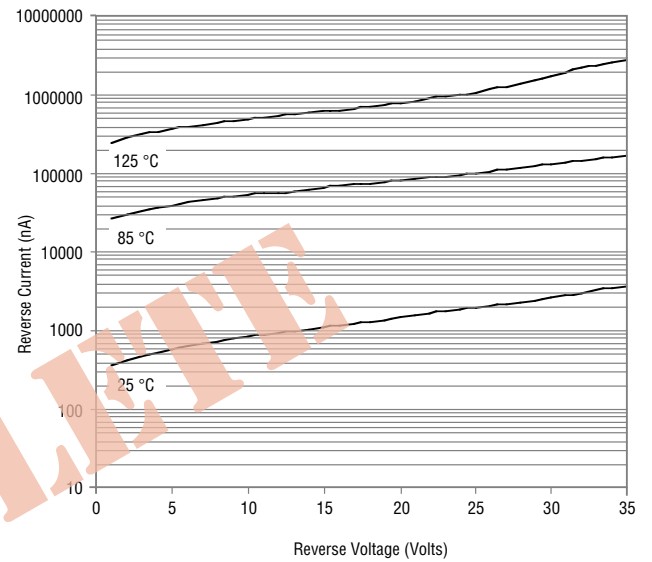
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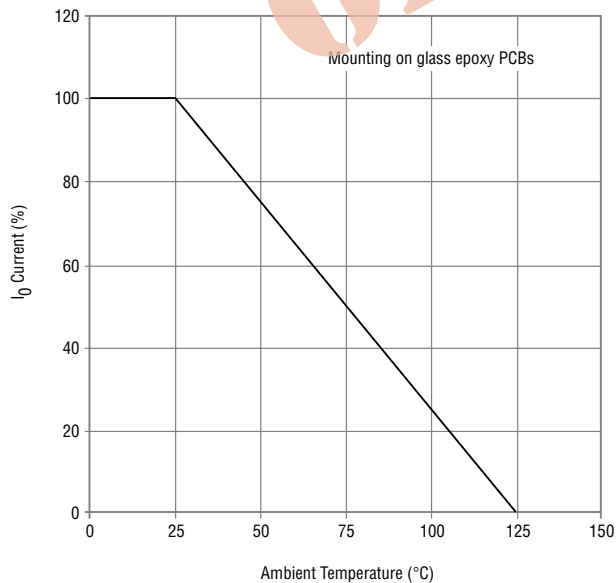
Forward Characteristics



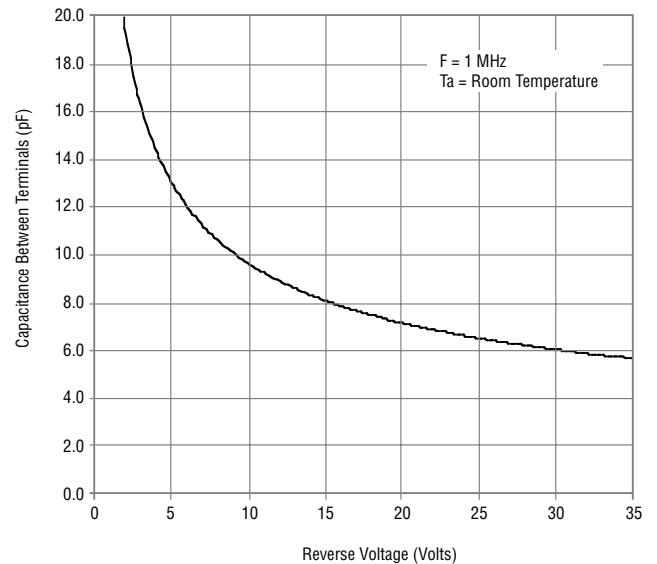
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

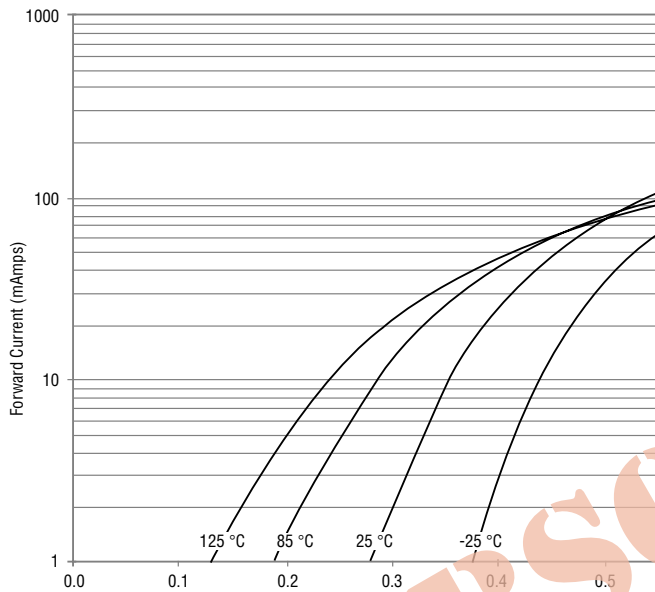


Schottky Barrier Chip Diode Series - 0805

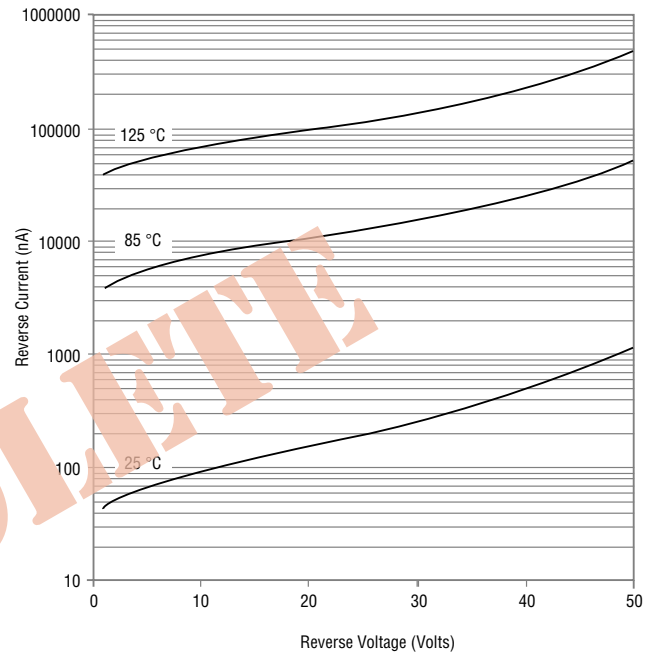
BOURNS®

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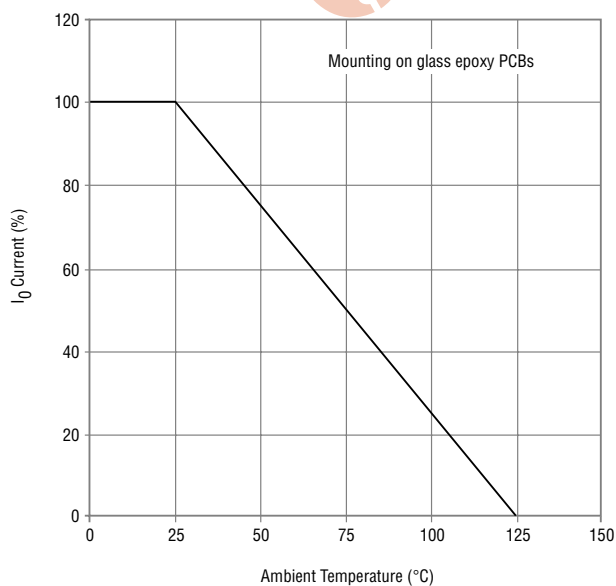
Forward Characteristics



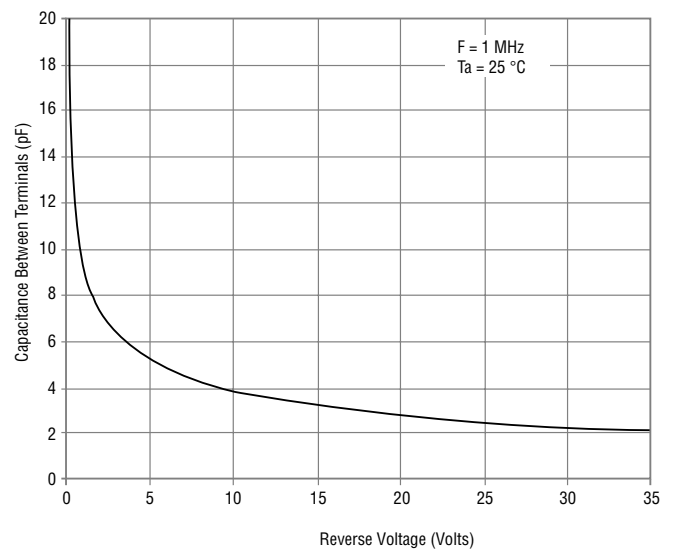
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

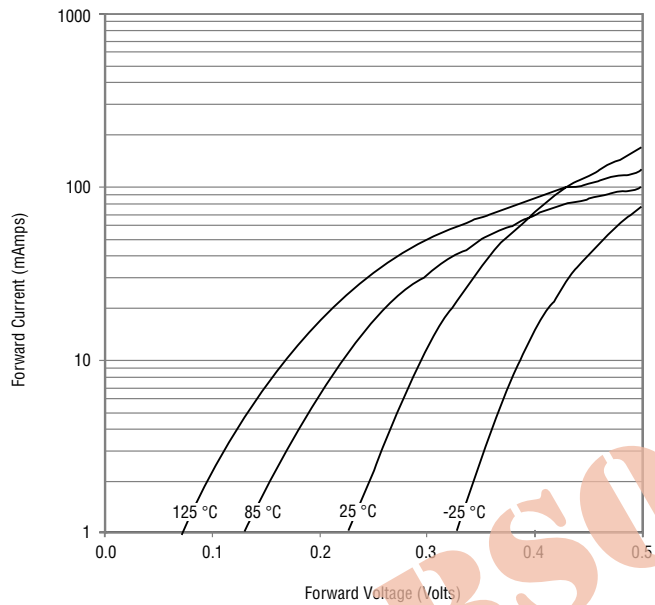


Schottky Barrier Chip Diode Series - 0805

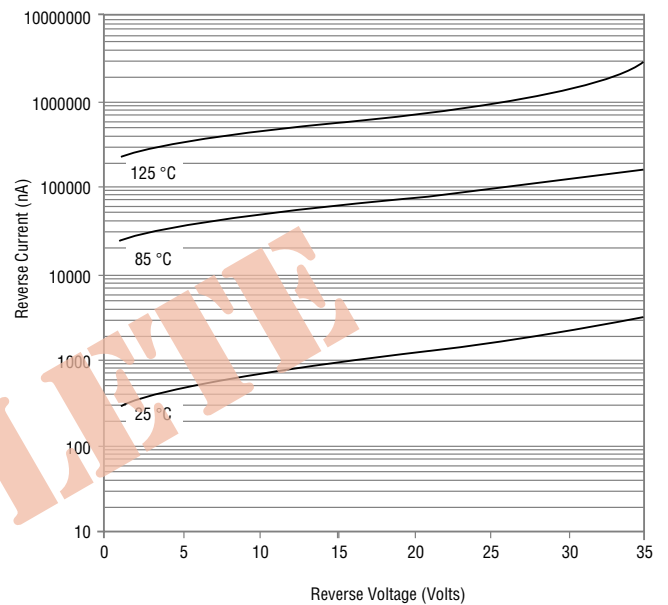
BOURNS®

Rating and Characteristic Curves: CD0805-B0230

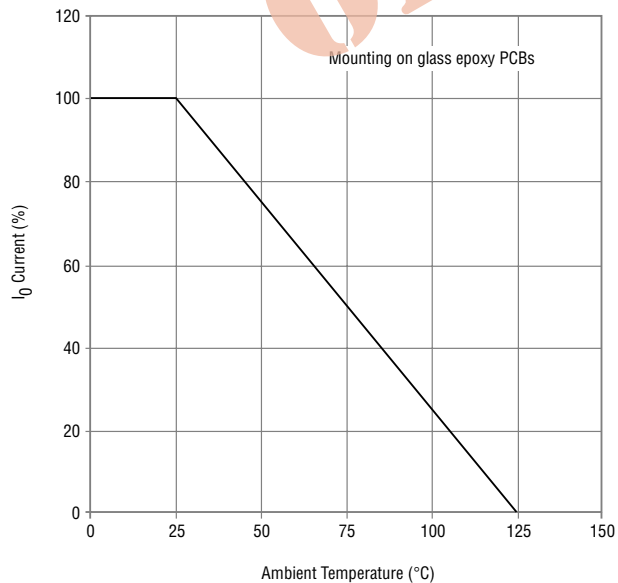
Forward Characteristics



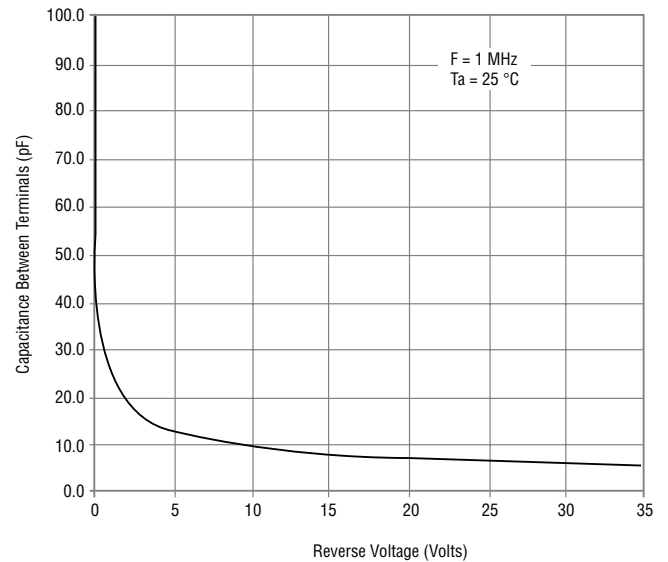
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

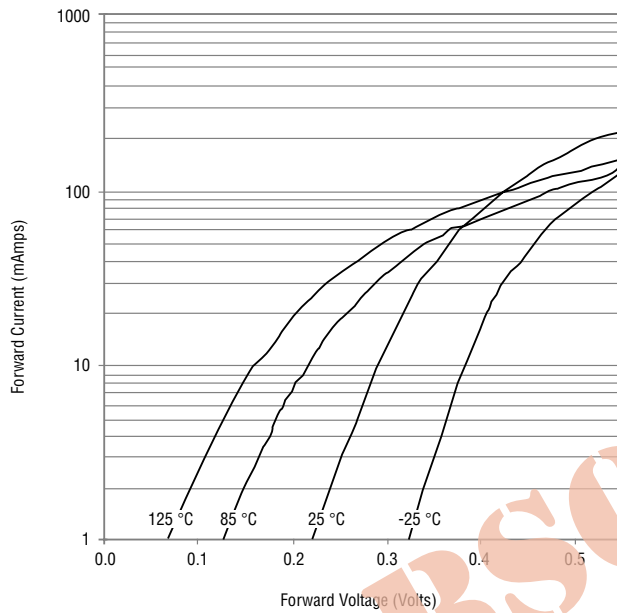


Schottky Barrier Chip Diode Series - 0805

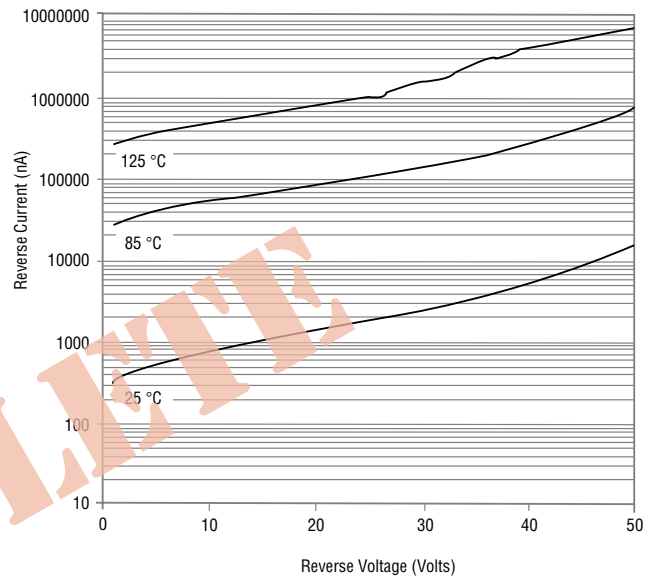
BOURNS®

Rating and Characteristic Curves: CD0805-B0245

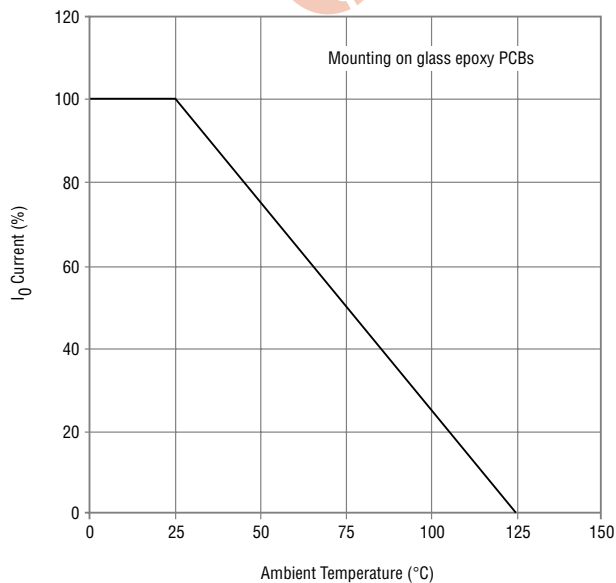
Forward Characteristics



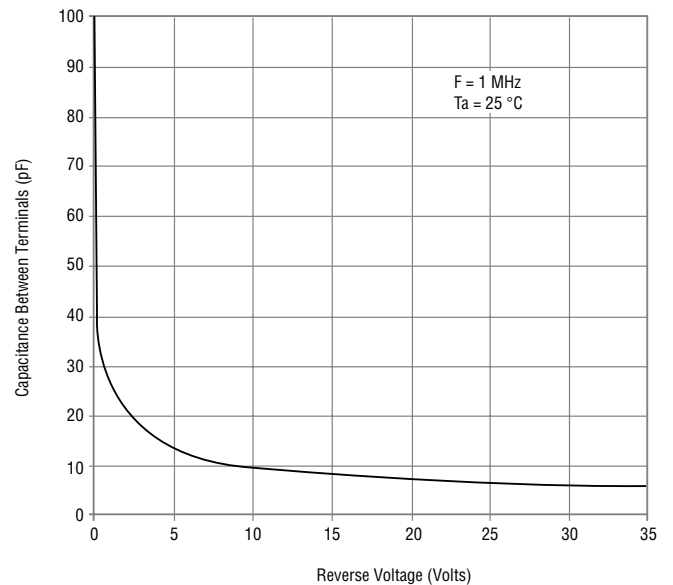
Reverse Characteristics



Derating Curve



Capacitance Between Terminals



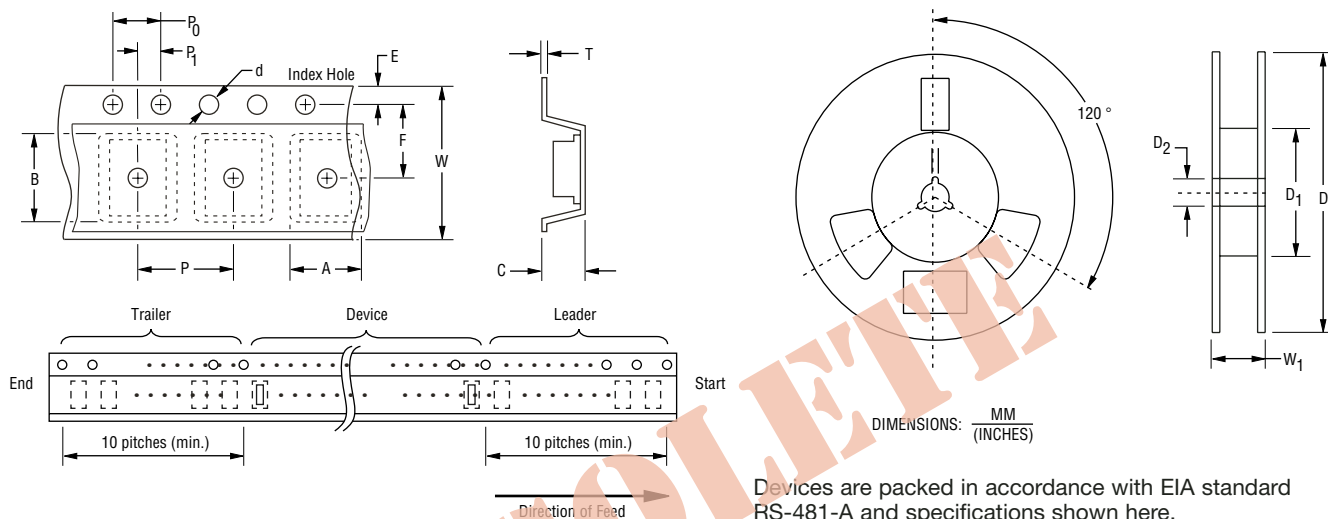
Specifications are subject to change without notice.
Customers should verify actual device performance in their specific applications.

Schottky Barrier Chip Diode Series - 0805

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Packaging Information

The product will be dispensed in Tape and Reel format (see diagram below).



Item	Symbol	0805
Carrier Width	A	1.55 ± 0.10 (0.061 - 0.004)
Carrier Length	B	2.30 ± 0.10 (0.091 - 0.004)
Carrier Depth	C	1.25 ± 0.10 (0.049 - 0.004)
Sprocket Hole	d	1.55 ± 0.05 (0.061 - 0.002)
Reel Outside Diameter	D	178 (7.008)
Reel Inner Diameter	D ₁	60.0 (2.362) MIN.
Feed Hole Diameter	D ₂	13.0 ± 0.20 (0.512 - 0.008)
Sprocket Hole Position	E	1.75 ± 0.10 (0.069 - 0.004))
Punch Hole Position	F	3.50 ± 0.05 (0.138 - 0.002)
Punch Hole Pitch	P	4.00 ± 0.10 (0.157 - 0.004)
Sprocket Hole Pitch	P ₀	4.00 ± 0.10 (0.157 - 0.004)
Embossment Center	P ₁	2.00 ± 0.05 (0.079 - 0.002)
Overall Tape Thickness	T	0.25 ± 0.05 (0.010 - 0.002)
Tape Width	W	8.00 ± 0.20 (0.315 - 0.008)
Reel Width	W ₁	13.5 (0.531) MAX.
Quantity per Reel	--	3,000

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Bourns:

[CD0805-S0180R](#)